IEEE EDTM2020 Report Session

IEEE EDS, 4th Electron Devices Technology and Manufacturing (EDTM) Conference 2020 (http://ewh.ieee.org/conf/edtm/2020/) was held on April 6-21.

The report session of EDTM-2020 will be held on July 27, 2020, as follows.

***** IEEE EDTM 2020 報告会詳細 *****

(Cooperated by IEEE EDS Japan Joint Chapter)

Date: July 27, 2020 13:20-15:40Venue: Virtual session by Webex

■ Registration Fee: FREE

■ Program:

13:20-13:40	Summary of EDTM2020	Kazunari Ishimaru (Kioxia)
13:40-14:20	Subcommittee on Process	Anupam Mitra (Kioxia)
14:20-15:00	Subcommittee on Modeling	Risho Koh (Renesas Electronics)
15:00-15:40	Subcommittee on Si Devices	Masumi Saitoh (Kioxia)
15:40	Next year's EDTM plans	Shuji Ikeda (tei solutions)

IEEE EDTM 2021 is planned as an in-person/on-site event in Chengdu, China, on March 9-12, 2021. Paper submission deadline will be October 25, 2020. The accepted paper will be published on IEEE Xplore Digital Library and J-EDS special issue.

https://ewh.ieee.org/conf/edtm/2021/

■ Contact

Hitoshi Wakabayashi (Tokyo Institute of Technology) wakabayashi.h.ab@m.titech.ac.jp Masaharu Kobayashi (The University of Tokyo) masa-kobayashi@nano.iis.u-tokyo.ac.jp

IEEE EDS Japan Joint Chapter web site:

http://www.ieee-jp.org/japancouncil/chapter/ED-15/